DECLARATION AND POWER OF ATTORNEY FOR UNITED STATES PATENT APPLICATION

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

BIOABSORBABLE PLUG IMPLANTS AND METHOD FOR BONE TISSUE REGENERATION

the specification	on of wh	ich:	
(check one)			
(cricck one)	[2 x]		as U.S. Application Serial No.
-	r j	and was amended on	(if applicable).
the claims, as	amended	by any amendment referred	
_	rial to pa	tentability as defined in Title	ates Patent and Trademark Office all information known to 237, Code of Federal Regulations Code of Federal
above invention	on, and w		n which I do not claim priority, but which relates to the or inventor's certificate or PCT International application has n which priority is claimed.
Number		Country	Day/Month/Year Filed
Number	(Country	Day/Month/Year Filed
365(b) of any	foreign a	application(s) for patent or in on which designated at least of	35, United States Code, Section 119(a)-(d) or Section ventor's certificate, or Section 365(a) of any PCT one country other than the United States, listed below and
Prior Foreign	Applicat	ion(s):	
Number		Country	Day/Month/Year Filed
Number		Country	Day/Month/Year Filed
			t .

I hereby claim the benefit under 35 U.S.C. Section 119(e) of any United States provisional application(s) listed below:

(Application Serial No.)	(Filing Date)	
60/524,278	21 November 2003 (21.11.2003)	
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	

I hereby claim the benefit under 35 U.S.C. Section 120 of any United States application(s), or Section 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. Section 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, C.F.R., Section 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

(Application Serial No.)	(Filing Date)	(Status) (Patented, pending, abandoned)
PCT/SG2004/000380	22 November 2004	Pending
(Application Serial No.)	(Filing Date)	(Status) (Patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (Patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

All practitioners associated with Customer No. 23405

Send Correspondence to:

Victor A. Cardona

Heslin Rothenberg Farley & Mesiti P.C.

5 Columbia Circle

Albany, New York 12203

Direct Telephone Calls to: Victor A. Cardona (518) 452-5600

Full name of Sole or First Inventor:						
Swee Hin TEOH						
	·					
Inventor's Signature	Date:					
Residence:	Citizenship					
22 Toh Yi Road, Singapore 596504	Singapore					
Mailing Address:						
22 Toh Yi Road, Singapore 596504						
, 31						
Full name of Second Inventor:						
Kim Cheng TAN						
Inventor's Signature	Date:					
Residence:	Citizenship					
Blk 856D Tampines Street 82 #12-180, Singapore	Singapore					
524856						
Malling Address.						
Mailing Address:						
Blk 856D Tampines Street 82 #12-180, Singapore 524856	•					
Full name of Third Inventor:						
Dietmar HUTMACHER						
Inventor's Signature	Date:					
Residence:	Citizenship					
48 Toh Tuck Road, #03-07 Signature Park, Singapore	Germany					
596739						
Mailing Address:						
48 Toh Tuck Road, #03-07 Signature Park, Singapore 596739						

Full name of Fourth Inventor: Thiam Chye LIM	
Inventor's Signature	Date:
Residence:	Citizenship
1 Jalan Anak Bukit, #08-01 Sherwood Tower, Singapore 588996	Malaysia
Mailing Address: 1 Jalan Anak Bukit, #08-01 Sherwood Tower, Singapore	588996
Full name of Fifth Inventor: Jan-Thorsten SCHANTZ	
Inventor's Signature	Date:
Residence:	Citizenship
43 Hume Avenue, #08-01 Symphony Heights, Singapore 598739	Germany
Mailing Address: 43 Hume Avenue, #08-01 Symphony Heights, Singapore	598739
Full name of Sixth Inventor: Ning CHOU	
Inventor's Signature	Date:
Residence:	Citizenship
18 Bo Seng Avenue, Singapore 309810	Singapore
Mailing Address: 18 Bo Seng Avenue, Singapore 309810	